

**PATENT APPLICATION**

Attorney Docket: 54364

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**H 3  
9/16/02  
Jaw

Applicant: Gupta, et al.

Serial No.: 09/847,667

Filed: 5/1/01

For: Method for Bonding Wafers to  
Produce Stacked Integrated Circuits

Group Art Unit: 2827

Examiner: James Mitchell

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SEP 11 2002

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HON. ASSISTANT COMMISSIONER OF PATENTS  
AND TRADEMARKS  
Washington, DC 20231**TRANSMITTAL OF AMENDMENT AND PETITION FOR EXTENSION OF TIME**

In response to the office action dated 3/13/02, Applicant submits herewith an amendment in the above-identified patent application and petitions the Commissioner for a three month extension of time. Applicant is a Small Entity. Hence, Applicant believes the required fee is \$460. The Commissioner is hereby authorized to charge this fee and any additional fees which may be required in this application under 37 C.F.R. Section 1.16-1.17 during its entire pendency, or credit any overpayment, to Deposit Account No. 23-0424. Should no proper payment be enclosed herewith, as by a check being in the wrong amount, unsigned, post-dated, otherwise improper or informal or even entirely missing, the Commissioner is authorized to charge the unpaid amount to Deposit Account No. 23-0424. This sheet is filed in duplicate.

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